Dual N-Channel, Digital FET

FDG6301N-F085

Features

- 25 V, 0.22 A Continuous, 0.65 A Peak
- $R_{DS(ON)} = 4 \Omega @ V_{GS} = 4.5 V$,
- $R_{DS(ON)} = 5 \Omega @ V_{GS} = 2.7 V.$
- Very Low Level Gate Drive Requirements allowing Directop— Eration in 3 V Circuits (V_{GS(th)}< 1.5 V)
- Gate–Source Zener for ESD Ruggedness (>6 kV Human Body Model)
- Compact Industry Standard SC70-6 Surface Mount Package.
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

 Low Voltage Applications as a Replacement for Bipolar Digital Transistors and Small Signal MOSFETs

MOSFET MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Ratings	Units
VDSS	Drain to Source Voltage	25	V
Vgs	Gate to Source Voltage	8	V
ΙD	Drain Current Continuous	0.22	А
	Pulsed	0.65	
Pb	Power Dissipation	0.3	W
ТJ, Tsтg	Operating and Storage Temperature	-55 to 150	°C
ESD	Electrostatic Discharge Rating MIL-STD-883D Human Body Model (100 pF / 1500 W)	6.0	kV
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	415	°C/W

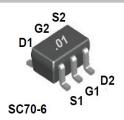
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. $R_{\theta JA}$ is the sum of the junction–to–case and case–to–ambient thermal resistance, where the case thermal reference is defined as the Solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design, while $R_{\theta JA}$ is determined by the board design. $R_{\theta JA}$ = 415 °C/W on minimum pad mounting on FR–4 board in still air.
- A suffix as "...F085P" has been temporarily introduced in order to manage a double source strategy as ON Semiconductor has officially announced in August 2014.
- 3. Pulse Test: Pulse Width < 300 μs, Duty Cycle < 2.0%

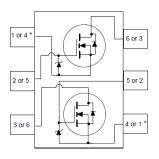


ON Semiconductor®

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SC-88 (SC-70 6 Lead), 1.25x2 CASE 419AD



ORDERING INFORMATION

Device	Device Marking	Package	Shipping [†]
FDG6301N-F085	FDG6301N	SC-88 (SC-70 6 Lead) (Pb-Free, Halogen Free)	3,000 units / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D

FDG6301N-F085

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Off Characteristics						
Drain to Source Breakdown Voltage	Bvdss	$I_D = 250 \mu A, V_{GS} = 0 V$	25			V
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 20 V, V _{GS} = 0 V			1	μΑ
		$T_J = 55^{\circ}C$			10	
Gate to Source Leakage Current	Igss	V _{GS} = ±8 V			±100	nA
On Characteristics						
Gate to Source Threshold Voltage	VGS(th)	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	0.65	0.85	1.5	٧
Drain to Source On Resistance	rDS(on)	I _D = 0.22 A, V _{GS} = 4.5 V		2.6	4	Ω
		I _D = 0.19 A, V _{GS} = 2.7 V		3.7	5	
		I _D = 0.22 A, V _{GS} = 4.5 V, T _J = 125°C		5.3	7	
On-State Drain Current	ID(on)	V _{GS} = 4.5 V, V _{DS} = 5 V	0.22			
Forward Transconductance	gFS	I _D = 0.22 A, V _{DS} = 5 V		0.2		s
Dynamic Characteristics						
Input Capacitance	Ciss	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		9.5		pF
Output Capacitance	Coss			6		pF
Reverse Transfer Capacitance	Crss			4.5		pF
Total Gate Charge at -4.5 V	Qg(TOT)	$V_{GS} = 0$ to 4.5 V; $V_{DD} = 5$ V, $I_D = 0.22$ A		0.29	0.4	nC
Gate to Source Gate Charge	Qgs	V _{DD} = 5 V _, I _D = 0.22 A		0.12		
Gate to Drain "Miller" Charge	Qgd			0.03]
Switching Characteristics						
Turn-On Delay Time	td(on)	$V_{DD} = 5 \text{ V}, I_{D} = 0.5 \text{ A}, V_{GS} = 4.5 \text{ V},$ $R_{GEN} = 50 \Omega$		5	10	ns
Rise Time	t _r			4.5	10	ns
Turn-Off Delay Time	td(off)			4	8	ns
Fall Time	t _f			3.2	7	ns
Drain-Source Diode Characteristics		-		•	*	•
Maximum Continuous Source Current	Is				0.25	А
Source to Drain Diode Voltage	Vsd	I _{SD} = 0.25 A, V _{GS} = 0 V		0.8	1.2	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

FDG6301N-F085

TYPICAL CHARACTERISTICS

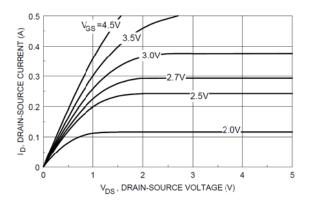


Figure 1. On-Region Characteristics

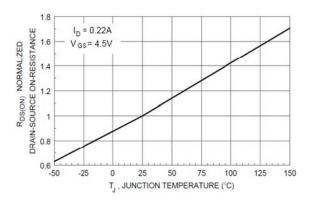


Figure 3. On-Resistance Variation with Temperature

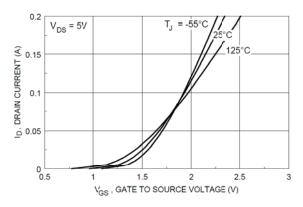


Figure 5. Transfer Characteristics

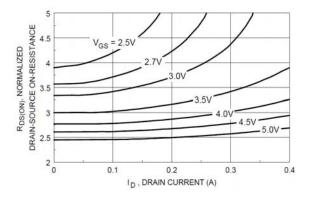


Figure 2. On–Resistance Variation with Drain Current and Gate Voltage

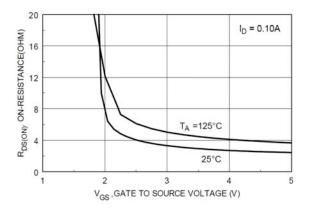


Figure 4. On–Resistance Variation with Gate–to–Source Voltage

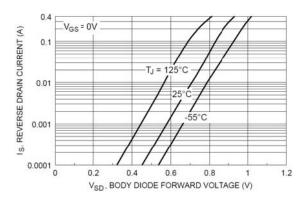


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature

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TYPICAL CHARACTERISTICS

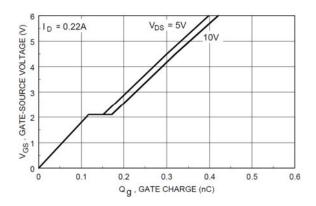


Figure 7. Gate Charge Characteristics

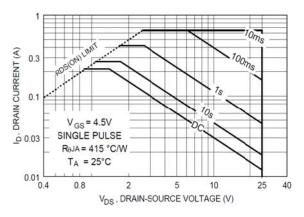


Figure 9. Maximum Safe Operating Area

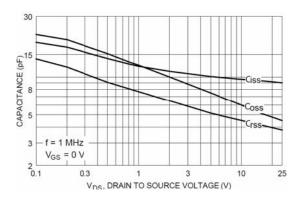


Figure 8. Capacitance Characteristics

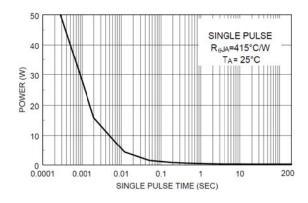


Figure 10. Single Pulse Maximum Power Dissipation

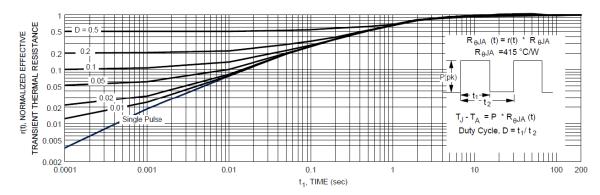


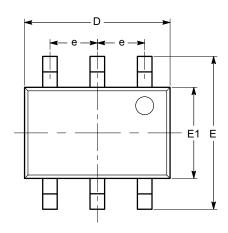
Figure 11. Transient Thermal Response Curve



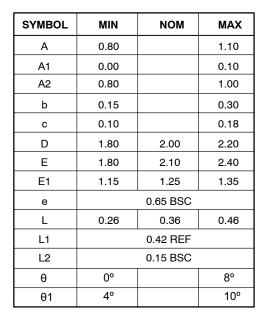


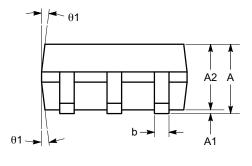
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DATE 07 JUL 2010

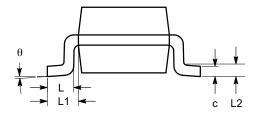


TOP VIEW





SIDE VIEW



END VIEW

Notes:

- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC MO-203.

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